

/ Descriptions

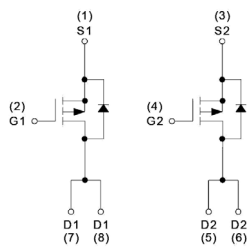
SOP-8 P MOS

/ Features

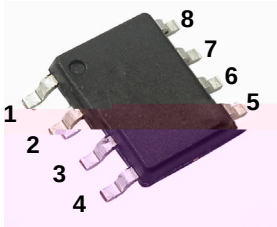
○

/ Applications

/ Equivalent Circuit



/ Pinning



/ Marking

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/ Absolute Maximum Ratings(Ta=25)

	℃		
	℃		
			℃
			℃
	θ		℃

≤

/ Electrical Characteristics(Ta=25)

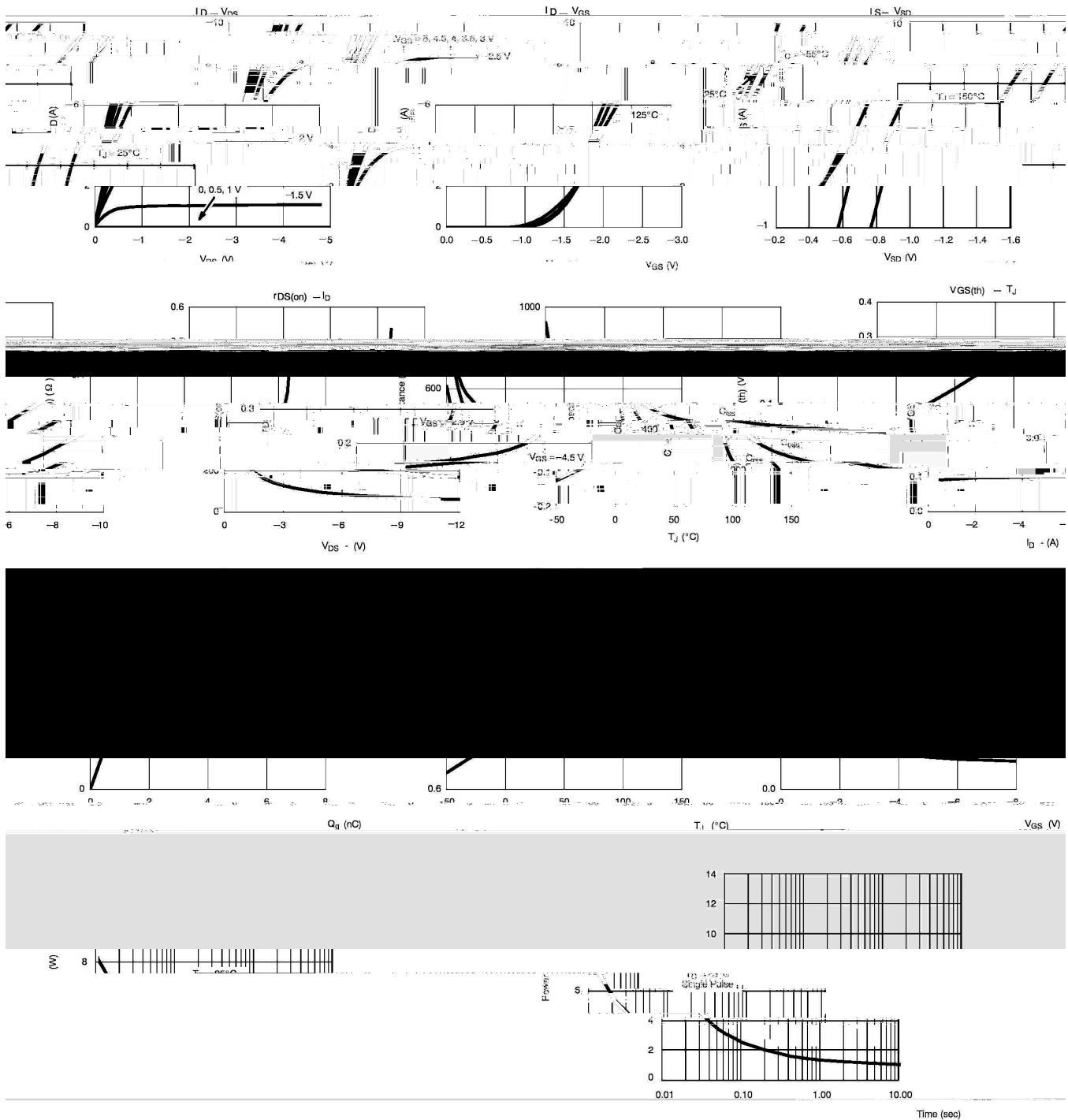
		μ				
						μ
		μ				
						Ω

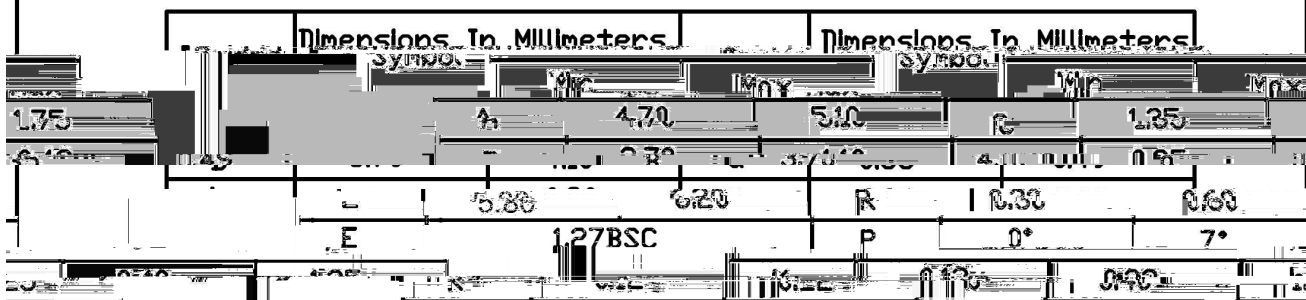
/ Electrical Characteristics(Ta=25)

						Ω
		Ω				

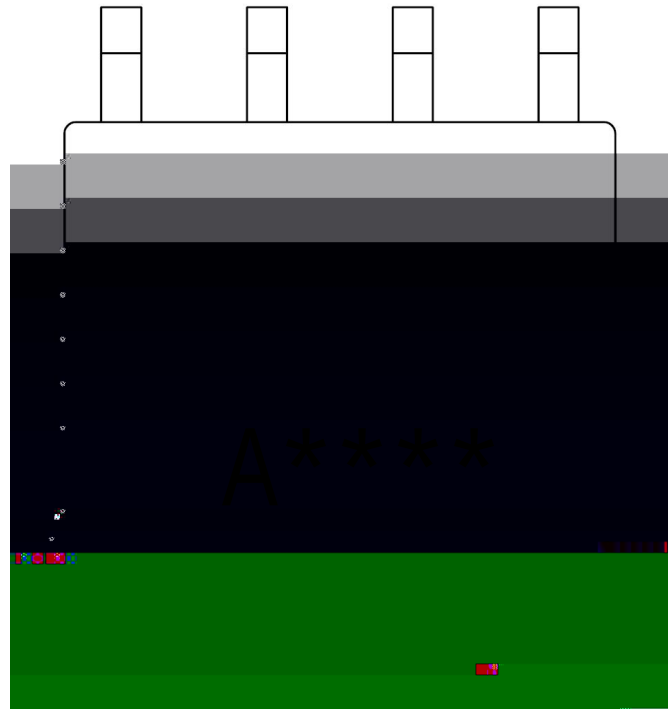
≤ μ ≤

I Electrical Characteristic Curve

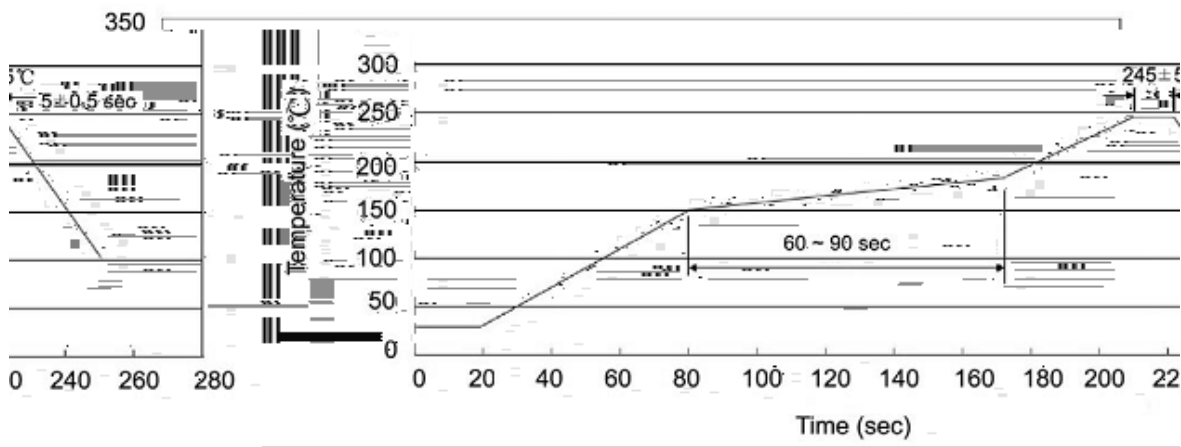




/ Marking Instructions



() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ± °C

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOP/ESOP-8	4,000	2	8,000	6	48,000	13" ×12	360×360×50	380×335×366

/ Notices